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DC-0.5GHz, 25W, 50V LDMOS Fully matched PA Module

Description

The IMGV0005-25 is a 25-watt ,single stage integrated Power Amplifier Module, designed for broad band applications, with frequencies from DC to 0.5GHz. The module is 50 Ω input/output matched and requires minimal external components.



The module implements distributed power amplifier in form of multi chips, housed in cost effective plastic open cavity package, offers a much lower cost than traditional MMIC solutions.

Vds=50V, Idq=150mA, CW

Parameter	13.56MHz	30MHz	100MHz	200MHz	300MHz	400MHz	500MHz	600MHz	Units
Linear Gain	19.9	18.8	18. 1	17.9	18.3	18.6	18.4	18.2	dB
Gain@Pin=30dBm	14.8	14.6	14.6	14. 5	14. 7	14.6	14. 5	14. 1	dB
Pout@Pin=30dBm	31.3	29.2	29. 1	28.5	29.7	28. 7	28.0	25. 7	W
Eff@Pin=30dBm	75	79	76	67	62	54	50	44	%

Product Features

• Operating Frequency Range: DC-0.5GHz

• Operating Drain Voltage: +50 V

• 50 Ω Input/Output

• Psat: ≥25W

• Small signal gain:>17dB, Power gain:>14dB

• Minimum efficiency:>50%

• 6x10 mm Surface Mount Package

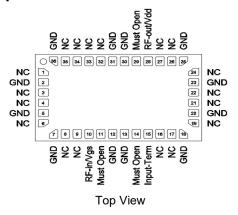
• Compliant to Restriction of Hazardous Substances (RoHS) Directive 2002/95/EC

• Much lower cost than GaN-based ultrawide band PA, due to LDMOS technology used

Applications

- Ultra Broadband Amplifiers
- Driver for ISM, FM
- Test Instrumentation
- EMC Amplifier Drivers
- HF/VHF 2-way Radios

Pin Configuration and Description





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Pin No.	Symbol	Description		
28	RFout/Vdd	Transistor 1, Drain Bias & RF Output		
10	RFin/Vgs	Transistor 1, RF Input &Gate Bias		
15	Input-Term	Transistor 1, Input 50 ohm term		
Others NC		No connection		
11, 14, 29	Must Open	Keep the pin open, no GND		
2,5,7,12,13,16,20,23,25, 30, 31,36 Package Base GND		DC/RF Ground. Must be soldered to EVB ground plane over array vias for thermal and RF performance. Solder voids under Pkg Base w result in excessive junction temperatures causing permanent damage		

Table 1. Maximum Ratings

Rating	Symbol	Value	Unit
DrainSource Voltage	V _{DSS}	115	Vdc
GateSource Voltage	V _{GS}	-10 to +10	Vdc
Operating Voltage	V _{DD}	+50	Vdc
Storage Temperature Range	Tstg	-65 to +150	°C
Case Operating Temperature	Tc	+150	°C
Operating Junction Temperature	T,	+200	°C

Table 2. Thermal Characteristics

Characteristic	Symbol	Value	Unit
Thermal Resistance, Junction to Case	Dave	4.7	00/11/
T _C = 25°C, DC test	Rejc	1.7	°C/W

Table 3. Electrical Characteristics

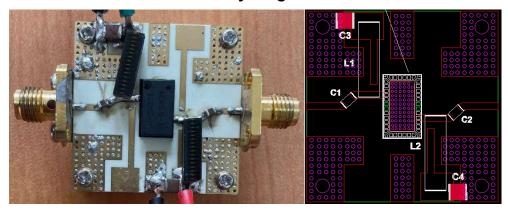
Parameter	Condition	Min	Тур	Max	Unit
Frequency Range	Pin=30dBm	1		500	MHz
Power Gain @ Psat	Pin=30dBm	14			dB
P _{SAT}	Pin=30dBm	44			dBm
Drain Efficiency @ P _{SAT} Pin=30dBm 50 %					
Unless otherwise noted: TA = 25°C, V _{DD} =50 V, Pulse Width=100 us, Duty cycle=10%					

Load Mismatch of per Section (On Test Fixture, 50 ohm system): $V_{DD} = 50 \text{ V}$, $I_{DQ} = 150 \text{ mA}$, f = 0.5 GHz

VSWR 10:1 at Psat pulse CW Output Power	No Device Degradation
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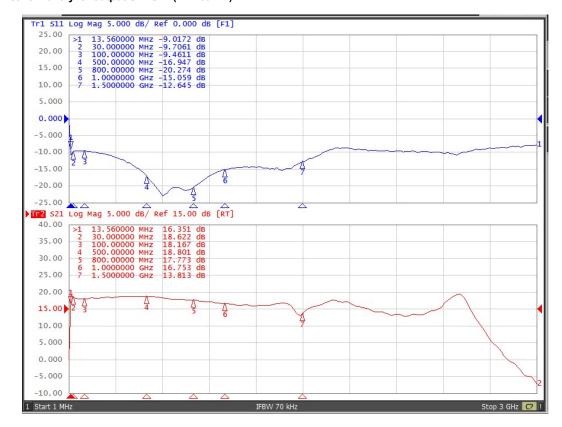
Reference Circuit of Test Fixture Assembly Diagram



		Part NO.	Vendor
C3,C4	10uF 100V Chip Capacitor	C5750X7S2A106M230KB	TDK
C1,C2	50V 1uF Chip Capacitor	GRM21BR71H105KA12L	muRata
L1,L2	1.3uH 4.2A Inductor	4310LC-132KEC	Coilcraft
РСВ	RO4350B,20mil,er=3.48		

TYPICAL CHARACTERISTICS

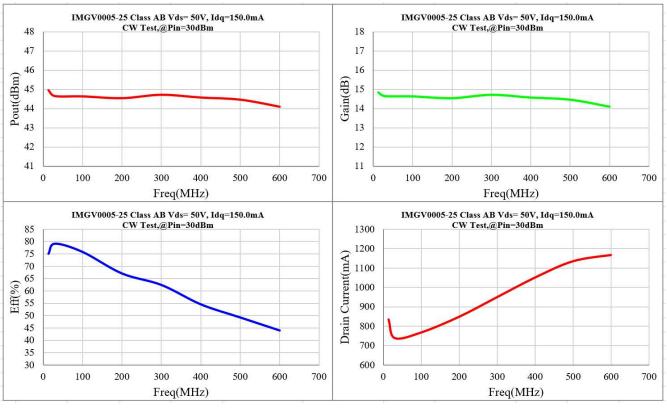
Figure 1. Network analyzer output S11/S21 (Pin=0dBm)

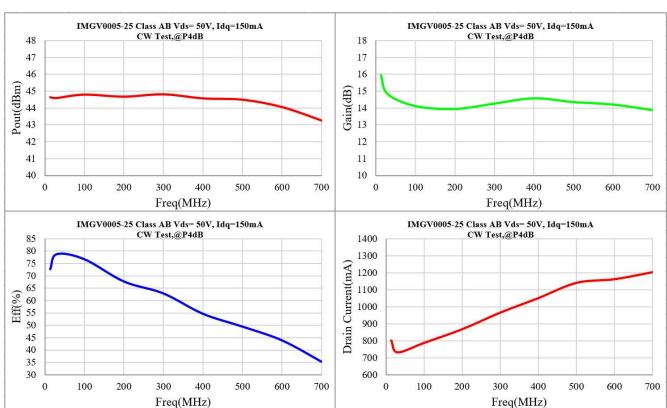




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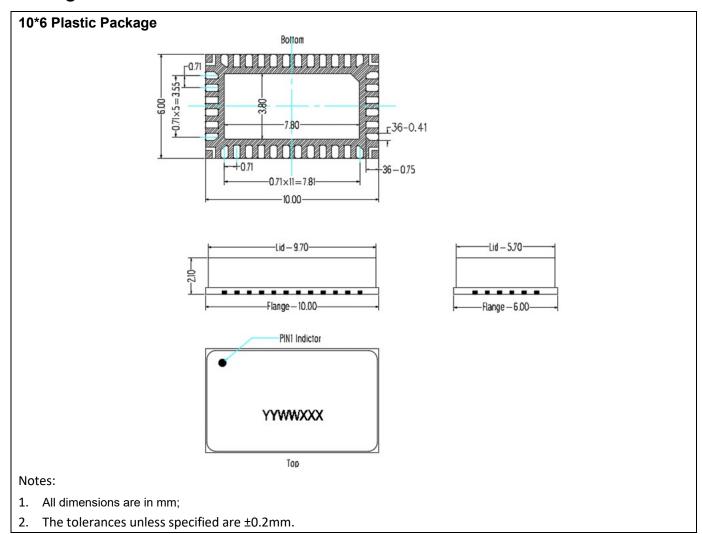
Figure. Power Gain and, efficiency and Pout @Pin=30dBm ,and P4dB vs. Frequency



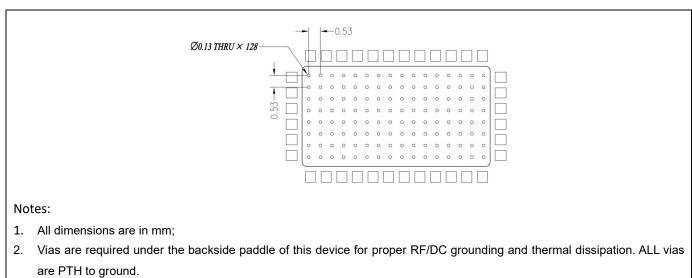


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Package Dimensions



Mounting Footprint Pattern



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Revision history

Table 6. Document revision history

Date	Revision	Datasheet Status
2023/3/29	Rev 1.0	Production Datasheet

Application data based on ZHH-23-06

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